



Trench gate field-stop IGBT, V series 600 V, 60 A very high speed

Datasheet - production data

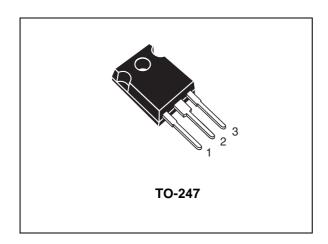
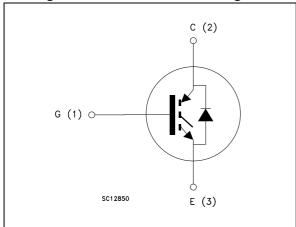


Figure 1. Internal schematic diagram



Features

- Maximum junction temperature: T_J = 175 °C
- Tail-less switching off
- V_{CE(sat)} = 1.85 V (typ.) @ I_C = 60 A
- Tight parameters distribution
- Safe paralleling
- Low thermal resistance
- Lead free package

Applications

- Photovoltaic inverters
- Uninterruptible power supply
- Welding
- Power factor correction
- · Very high frequency converters

Description

This device is an IGBT developed using an advanced proprietary trench gate field stop structure. The device is part of the V series of IGBTs, which represent an optimum compromise between conduction and switching losses to maximize the efficiency of very high frequency converters. Furthermore, a positive $V_{\text{CE}(\text{sat})}$ temperature coefficient and very tight parameter distribution result in safer paralleling operation.

Table 1. Device summary

Order code	Marking	Package	Packaging
STGW60V60F	GW60V60F	TO-247	Tube

Contents STGW60V60F

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STGW60V60F Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C	Continuous collector current at T _C = 25 °C	80 ⁽¹⁾	Α
I _C	Continuous collector current at T _C = 100 °C	60	Α
I _{CP} ⁽²⁾	Pulsed collector current	240	Α
V _{GE}	Gate-emitter voltage	±20	V
P _{TOT}	Total dissipation at T _C = 25 °C	375	W
T _{STG}	Storage temperature range	- 55 to 150	°C
TJ	Operating junction temperature	- 55 to 175	°C

^{1.} Current level is limited by bond wires

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal resistance junction-case IGBT	0.4	°C/W
R _{thJA}	Thermal resistance junction-ambient	50	°C/W

^{2.} Pulse width limited by maximum junction temperature and turn-off within RBSOA

Electrical characteristics STGW60V60F

2 Electrical characteristics

 $T_J = 25$ °C unless otherwise specified.

Table 4. Static characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 2 mA	600			٧
		V _{GE} = 15 V, I _C = 60 A		1.85	2.3	
V	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 60 A T _J = 125 °C		2.15		٧
	10 mage	$V_{GE} = 15 \text{ V}, I_{C} = 60 \text{ A}$ $T_{J} = 175 ^{\circ}\text{C}$		2.35		
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	5.0	6.0	7.0	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V			25	μΑ
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ± 20 V			250	nA

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies}	Input capacitance		-	8000	-	pF
C _{oes}	Output capacitance	$V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	280	-	pF
C _{res}	Reverse transfer capacitance	V _{GE} = 0	-	170	-	pF
Q_g	Total gate charge		-	334	-	nC
Q _{ge}	Gate-emitter charge	$V_{CC} = 480 \text{ V}, I_{C} = 60 \text{ A},$ $V_{GF} = 15 \text{ V}, \text{ see } Figure 23$	-	130	-	nC
Q _{gc}	Gate-collector charge	ige is i, est igus es	-	58	-	nC

Table 6. IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} ⁽¹⁾	Turn-on delay time		-	60	-	ns
t _r ⁽¹⁾	Current rise time		-	20	-	ns
(di/dt) _{on} ⁽¹⁾	Turn-on current slope		-	2365	-	A/μs
t _{d(off)}	Turn-off delay time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$	-	208	-	ns
t _f	Current fall time	see <i>Figure 22</i>	-	14	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses		-	0.75	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	0.55	-	mJ
E _{ts}	Total switching losses		-	1.3	-	mJ
t _{d(on)} ⁽¹⁾	Turn-on delay time		-	57	-	ns
t _r ⁽¹⁾	Current rise time		-	23	-	ns
(di/dt) _{on} ⁽¹⁾	Turn-on current slope	V = 400 V L = 60 A	-	2191	-	A/μs
t _{d(off)}	Turn-off delay time	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 175 ^{\circ}\text{C}, \text{ see}$	-	216	-	ns
t _f	Current fall time		-	27	-	ns
E _{on} ⁽¹⁾	Turn-on switching losses	Figure 22	-	1.5	-	mJ
E _{off} ⁽²⁾	Turn-off switching losses		-	0.8	-	mJ
E _{ts}	Total switching losses		-	2.3	-	mJ

Switching-on times and energy have been calculated applying the STGW60V60DF's co-pack diode in the high side of the test circuit in Figure 22. Both IGBT and diode are at the same temperature. Energy losses include reverse recovery of the diode.

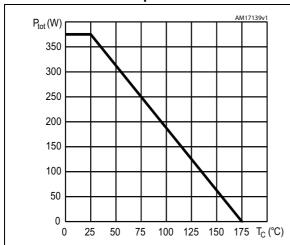
^{2.} Turn-off losses include also the tail of the collector current.

Electrical characteristics STGW60V60F

2.1 Electrical characteristics (curves)

Figure 2. Power dissipation vs. case temperature

Figure 3. Collector current vs. temperature case



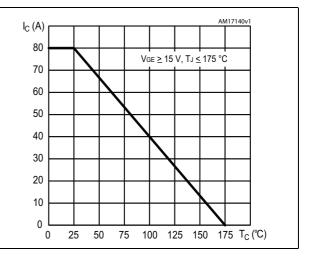
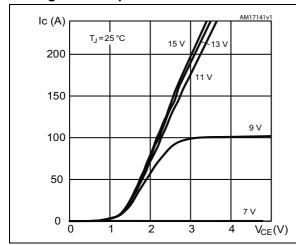


Figure 4. Output characteristics @ 25 °C

Figure 5. Output characteristics @ 175 °C



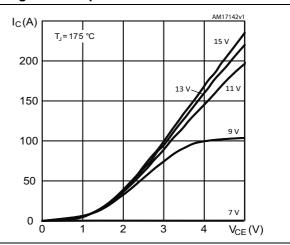
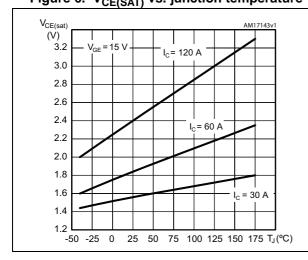


Figure 6. V_{CE(SAT)} vs. junction temperature

Figure 7. V_{CE(SAT)} vs. collector current



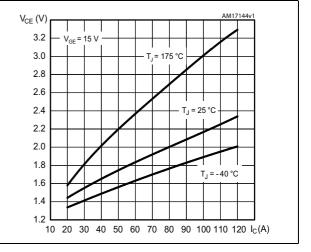
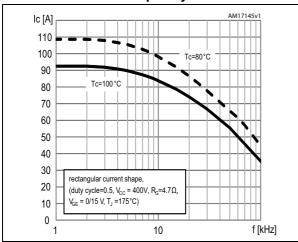


Figure 8. Collector current vs. switching frequency

Figure 9. Forward bias safe operating area for TO-247



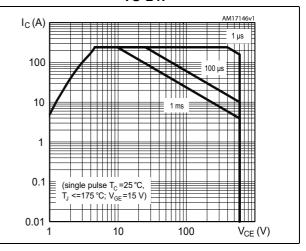
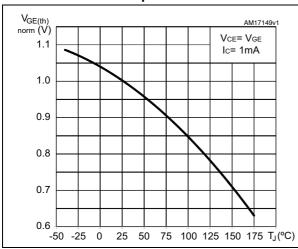


Figure 10. Normalized $V_{\text{GE(th)}}$ vs. junction temperature

Figure 11. Normalized BV_{CES} vs. junction temperature



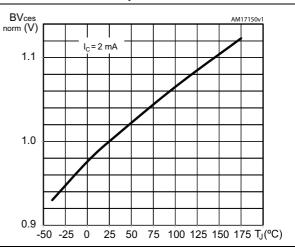
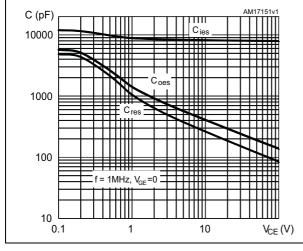
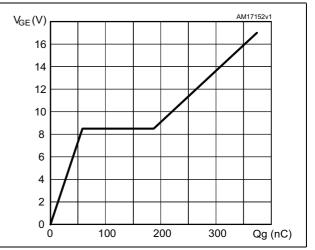


Figure 12. Capacitance variations

Figure 13. Gate charge vs. gate-emitter voltage

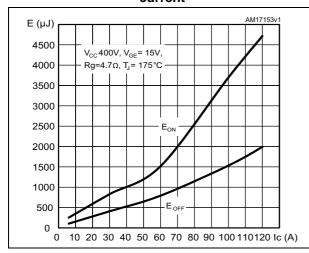




Electrical characteristics STGW60V60F

Figure 14. Switching losses vs. collector current

Figure 15. Switching losses vs. gate resistance



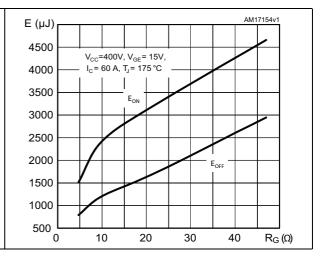
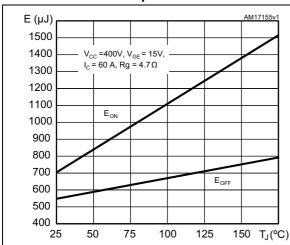


Figure 16. Switching losses vs. junction temperature

Figure 17. Switching losses vs. collector emitter voltage



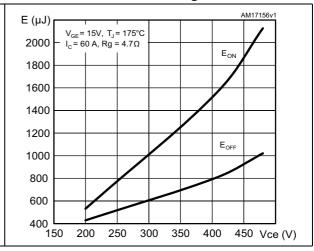
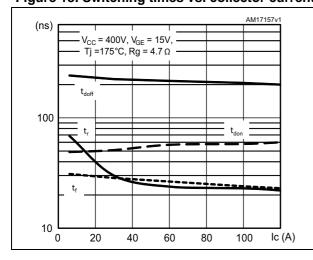
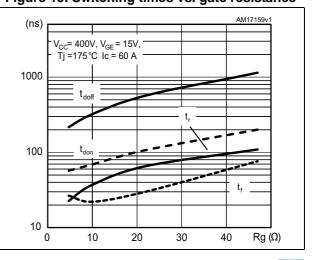


Figure 18. Switching times vs. collector current Figure 19. Switching times vs. gate resistance





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Figure 20. Transfer characteristics

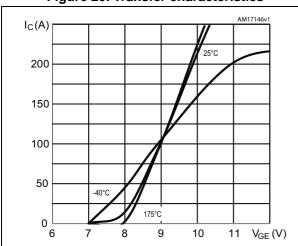
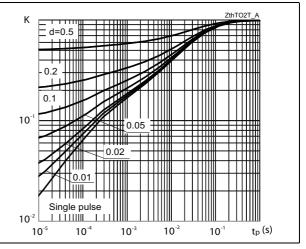


Figure 21. Thermal data



Test circuits STGW60V60F

3 Test circuits

Figure 22. Test circuit for inductive load switching

Figure 23. Gate charge test circuit

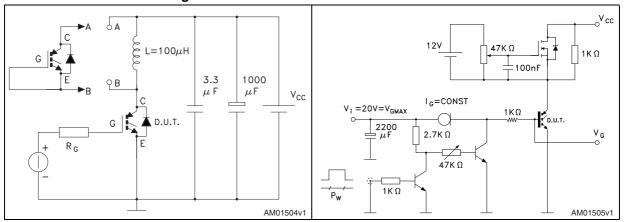
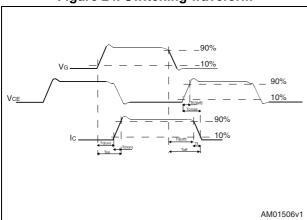


Figure 24. Switching waveform



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4 Package mechanical data

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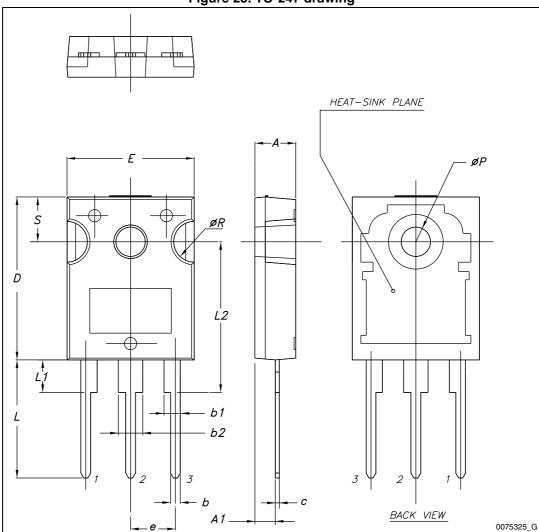


Figure 25. TO-247 drawing

Table 7. TO-247 mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

STGW60V60F Revision history

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
04-Jun-2013	1	Initial release.
06-Feb-2014	2	Updated Figure 1: Internal schematic diagram. Updated title, features and description in cover page. Minor text changes.

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Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com